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**ON Semiconductor®** 

# FDC6506P Dual P-Channel Logic Level PowerTrench<sup>™</sup> MOSFET

Features

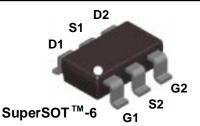
### **General Description**

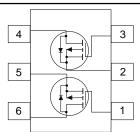
These P-Channel logic level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive SO-8 and TSSOP-8 packages are impractical.

### Applications

- Load switch
- Battery protection
- Power management





• -1.8 A, -30 V.  $R_{DS(on)} = 0.170 \ \Omega @ V_{GS} = -10 \ V$ 

• High performance trench technology for extremely

• SuperSOT<sup>TM</sup>-6 package: small footprint (72% smaller

than standard SO-8); low profile (1mm thick).

• Low gate charge (2.3nC typical).

• Fast switching speed.

low R<sub>DS(ON)</sub>.

 $R_{DS(on)} = 0.280 \ \Omega \ @ V_{GS} = -4.5 \ V$ 

## Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-30	V
V <sub>GSS</sub>	Gate-Source Voltage		<u>+</u> 20	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	-1.8	A
	- Pulsed		-10	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range		-55 to +150	۰C
Therma	I Characteristics			
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	∘C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	60	∘C/W

## **Package Outlines and Ordering Information**

Device Marking	Device	Reel Size	Tape Width	Quantity
.506	FDC6506P	7"	8mm	3000 units

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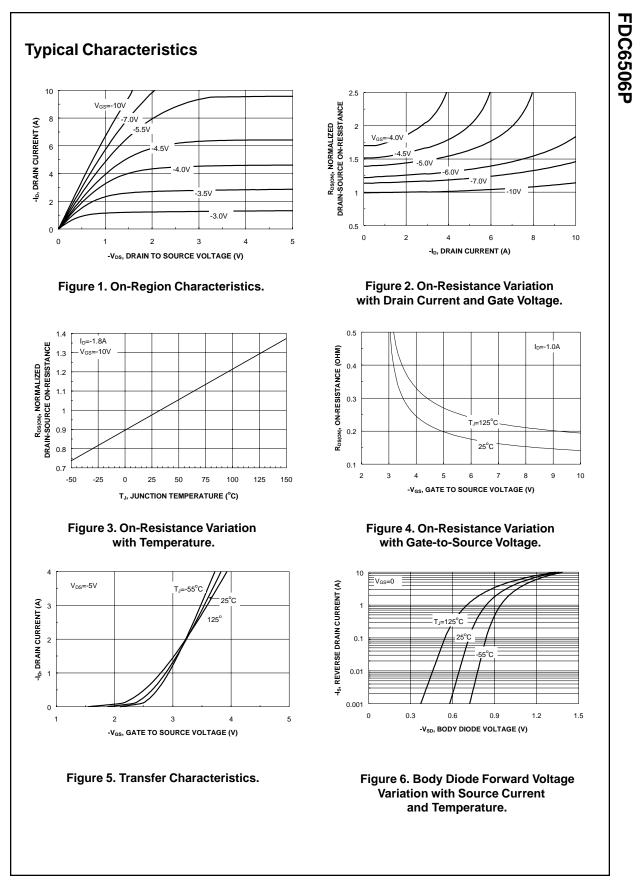
# FDC6506P

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = -250 $\mu$ A	-30			V
<u>A</u> BV⊡ss ∆Tj	Breakdown Voltage Temperature Coefficient	$I_D = -250 _{L}A$ , Referenced to $25 \circ C$		-20		mV/∘C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS}=20~V,~V_{DS}=0~V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
<u>A</u> VGS(th) ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		4		mV/∘C
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_D = -1.8 \text{ A}$ $V_{GS} = -10 \text{ V}, \text{ I}_D = -1.8 \text{ A} @ 125^{\circ}\text{C}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_D = -1.4 \text{ A}$		0.14 0.20 0.22	0.17 0.27 0.28	Ω
D(on)	On-State Drain Current	$V_{GS} = -10 \text{ V},  V_{DS} = -5 \text{ V}$	-10			А
FS	Forward Transconductance	$V_{DS} = -5 V, I_D = -1.8 A$		3		S
Dynamic	Characteristics					
	Input Capacitance	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$		190		pF
Coss	Output Capacitance	f = 1.0 MHz		70		pF
Crss Crss	Reverse Transfer Capacitance			30		pF
0		•		1	1	
	g Characteristics (Note 2)	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -1 \text{ A},$		7	14	ns
d(on) r	Turn-On Rise Time	$V_{DD} = -13 \text{ V},  \text{I}_{D} = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V},  \text{R}_{\text{GEN}} = 6 \Omega$		8	16	ns
d(off)	Turn-Off Delay Time			14	25	ns
d(011)	Turn-Off Fall Time	-		2	6	ns
, ל <sup>מ</sup>	Total Gate Charge	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -1.8 \text{ A},$ $V_{GS} = -10 \text{ V}$		2.3	3.5	nC
	Gate-Source Charge			1	0.0	nC
200	Gate-Drain Charge			0.8		nC
						-
⊋ <sub>gd</sub>						
ଦ୍ର ଦୁ <sub>ଗ</sub> Drain-So	urce Diode Characteristics and Maximum Continuous Drain-Source Dio	_			-0.8	Α

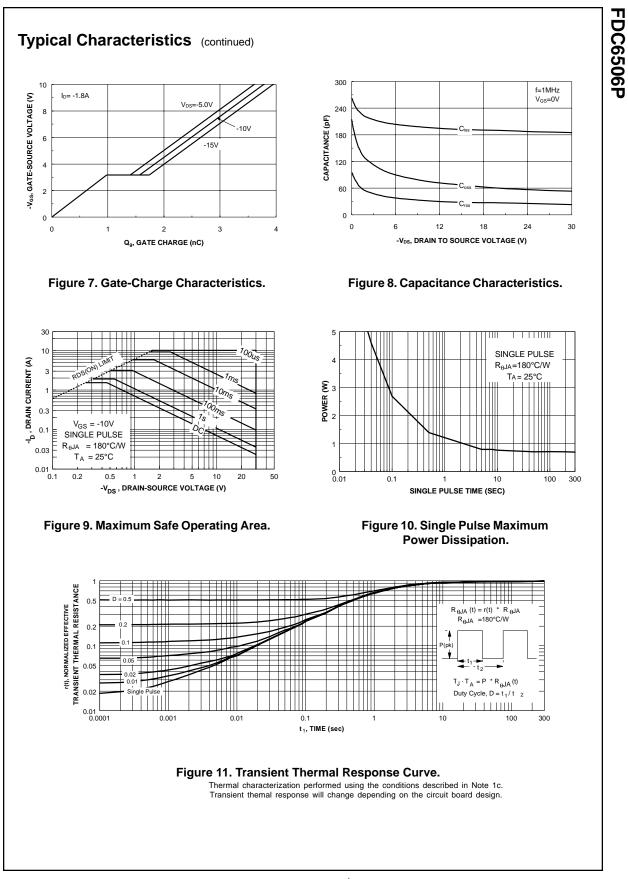
FDC6506P

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width  $\leq 300~\mu s,$  Duty Cycle  $\leq 2.0\%$ 

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